



#### 30V N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

### **Product Summary**

BV <sub>DSS</sub>	Rds(on)	I <sub>D</sub> T <sub>C</sub> = +25°C	
30V	$0.68m\Omega$ @ V <sub>GS</sub> = 10V	150A	
30 V	$1.1 \text{m}\Omega$ @ V <sub>GS</sub> = $4.5 \text{V}$	120A	

## **Description and Applications**

This new generation MOSFET is designed to minimize  $R_{DS(ON)}$  yet maintain superior switching performance. This device is ideal for use in notebook battery power management and load switches.

- Body control electronics
- DC-DC converters

#### **Features**

- 100% Unclamped Inductive Switch (UIS) Test in Production
- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low R<sub>DS(ON)</sub> Minimizes On-State Losses < 1.1mm Package Profile – Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. <a href="https://www.diodes.com/quality/product-definitions/">https://www.diodes.com/quality/product-definitions/</a>

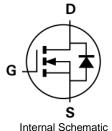
#### **Mechanical Data**

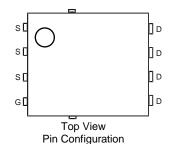
- Package: PowerDI<sup>®</sup>5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)





**Bottom View** 





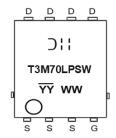
## **Ordering Information** (Note 4)

Part Number	Paskage	Packing		
Part Number	Package	Qty.	Carrier	
DMT3M70LPSW-13	PowerDI5060-8/SWP (Type UX)	2500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

# **Marking Information**



☐ I = Manufacturer's Marking

T3M70LPSW = Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 24 = 2024)

WW = Week Code (01 to 53)



### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Drain-Source Voltage	VDSS	30	V	
Gate-Source Voltage	$V_{GSS}$	±20	V	
Continuous Drain Current, $V_{GS} = 10V$ (Note 7) $ T_{C} = +25^{\circ}C $ $ T_{C} = +70^{\circ}C $		lo	150 125	А
Continuous Drain Current, V <sub>GS</sub> = 10V (Note 6) $ T_{A} = +25^{\circ}C $ $ T_{A} = +70^{\circ}C $		lo	61 49	А
Pulsed Drain Current (380µs Pulse, Duty Cycle = 1%)	I <sub>DM</sub>	600	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	4.48	Α	
Pulsed Body Diode Forward Current (380µs Pulse, Duty Cycle = 1	I <sub>SM</sub>	600	Α	
Avalanche Current, L = 0.3mH (Note 8)	las	48	Α	
Avalanche Energy, L = 0.3mH (Note 8)	Eas	345	mJ	

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	2.13	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{\theta JA}$	58.6	°C/W
Total Power Dissipation (Note 6)		PD	3.85	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	32.5	°C/W
Thermal Resistance, Junction to Case (Note 7)		R <sub>θ</sub> JC	1.04	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

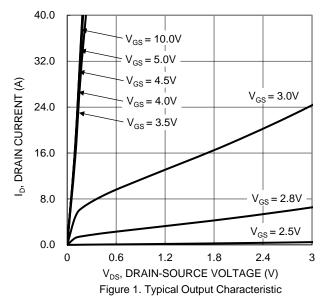
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 9)						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	30	_	_	V	$V_{GS} = 0$ , $I_D = 1mA$
Zero Gate Voltage Drain Current	IDSS	_		1	μΑ	V <sub>DS</sub> = 30V, V <sub>GS</sub> = 0
Gate-Source Leakage	Igss	_	ı	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0$
ON CHARACTERISTICS (Note 9)						
Gate Threshold Voltage	Vgs(TH)	1	_	3	V	$V_{DS} = V_{GS}$ , $I_D = 250\mu A$
Static Drain-Source On-Resistance	Dagger	_	0.58	0.68	mΩ	$V_{GS} = 10V, I_D = 20A$
Static Drain-Source On-Resistance	RDS(ON)	_	0.86	1.1		$V_{GS} = 4.5V, I_{D} = 20A$
Diode Forward Voltage	VsD	_	0.7	1	V	Vgs = 0, Is = 20A
DYNAMIC CHARACTERISTICS (Note 10)						
Input Capacitance	Ciss	_	11112	_	pF	45)(1)(
Output Capacitance	Coss	_	8689	_	pF	V <sub>DS</sub> = 15V, V <sub>GS</sub> = 0, -f = 1MHz
Reverse Transfer Capacitance	Crss	_	325	_	pF	
Gate Resistance	Rg	_	0.6	_	Ω	$V_{DS} = 0$ , $V_{GS} = 0$ , $f = 1MHz$
Total Gate Charge (V <sub>GS</sub> = 10V)	Qg	_	152.7	_	nC	
Total Gate Charge (V <sub>GS</sub> = 4.5V)	Qg	_	69.4	_	nC	V <sub>DS</sub> = 15V, I <sub>D</sub> = 20A
Gate-Source Charge	Qgs	_	28.8	_	nC	VDS = 15V, ID = 20A
Gate-Drain Charge	Qgd	_	10.3	_	nC	
Turn-On Delay Time	t <sub>D</sub> (ON)	_	15	_	ns	
Turn-On Rise Time	t <sub>R</sub>	_	29	_	ns	V <sub>DD</sub> = 15V, V <sub>GEN</sub> = 10V,
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	89	_	ns	$R_{GEN} = 6\Omega$ , $I_D = 24A$
Turn-Off Fall Time	t <sub>F</sub>	_	42	_	ns	

Notes:

- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
   Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
   Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8.  $I_{AS}$  and  $E_{AS}$  ratings are based on low frequency and duty cycles to keep  $T_J$  = +25°C.
- 9. Short duration pulse test used to minimize self-heating effect.
- 10. Guaranteed by design. Not subject to product testing.







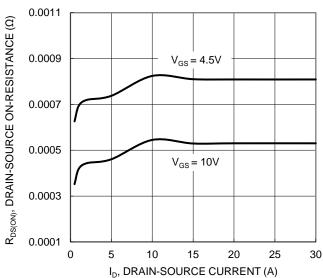


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

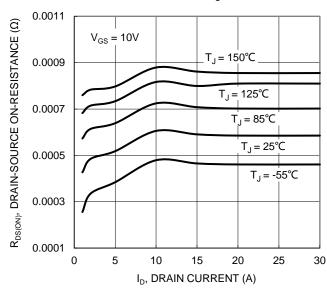


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

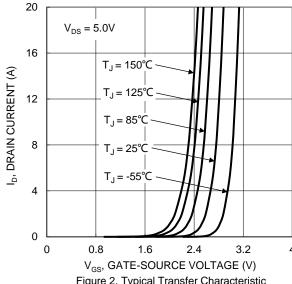


Figure 2. Typical Transfer Characteristic

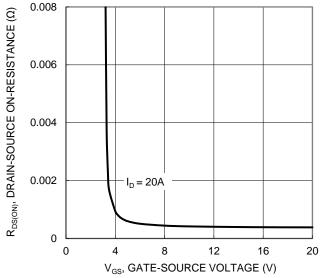


Figure 4. Typical Transfer Characteristic

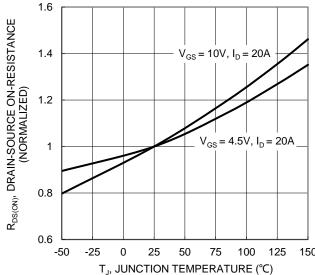


Figure 6. On-Resistance Variation with Junction Temperature





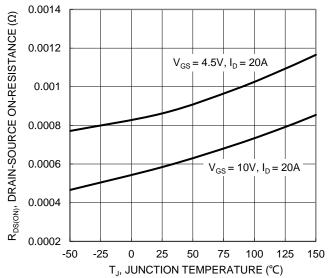


Figure 7. On-Resistance Variation with Junction Temperature

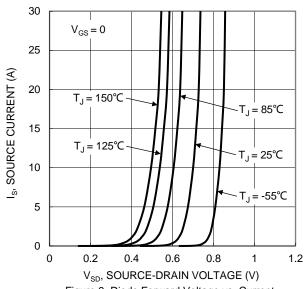


Figure 9. Diode Forward Voltage vs. Current

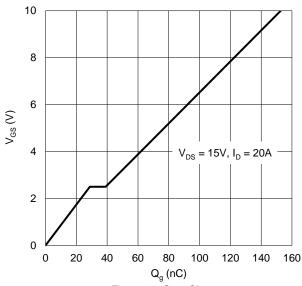


Figure 11. Gate Charge

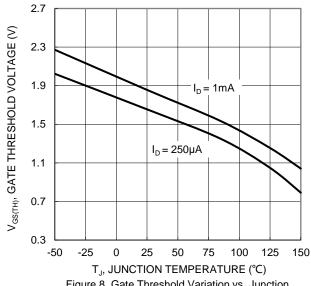
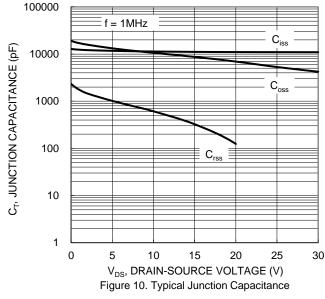


Figure 8. Gate Threshold Variation vs. Junction Temperature



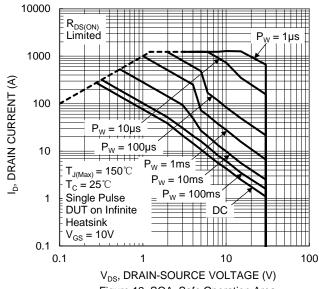


Figure 12. SOA, Safe Operation Area



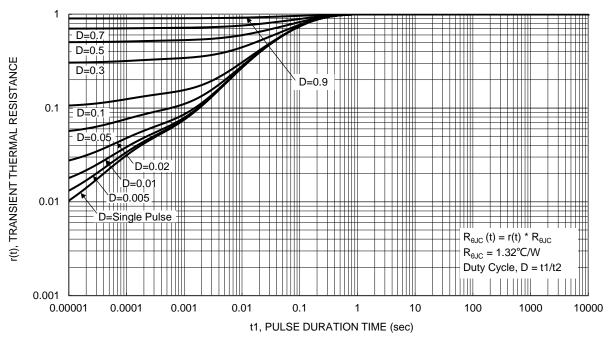


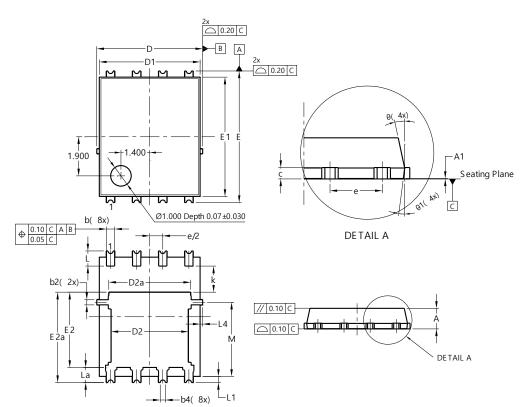
Figure 13. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### PowerDI5060-8/SWP (Type UX)

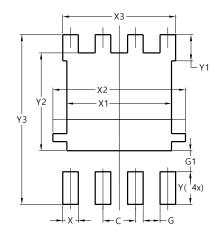


PowerDI5060-8/SWP (Type UX)				
Dim	Min	Max	Тур	
Α	0.90	1.10	1.00	
<b>A</b> 1	0	0.05		
b	0.30	0.50	0.41	
b2	0.20	0.35	0.25	
b4	0.25REF			
С	0.230	0.330	0.277	
D	5.15 BSC			
D1	4.70	5.10	4.90	
D2	3.56	3.96	3.76	
D2a	3.78	4.18	3.98	
Е	6	.40 BS0	)	
E1	5.60	6.00	5.80	
E2	3.46	3.86	3.66	
E2a	4.195	4.595	4.395	
е	1	.27BSC	;	
k	1.05			
L	0.635	0.835	0.735	
La	0.635	0.835	0.735	
L1	0.200	0.400	0.300	
L4	0.025	0.225	0.125	
М	3.205	4.005	3.605	
θ	10°	12°	11°	
θ1	6°	8°	7°	
All Dimensions in mm				

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### PowerDI5060-8/SWP (Type UX)



Dimensions	Value		
Dilliensions	(in mm)		
С	1.270		
G	0.660		
G1	0.820		
X	0.610		
X1	4.100		
X2	5.190		
Х3	4.420		
Y	1.270		
Y1	1.020		
Y2	3.810		
Y3	6.610		



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